## WHAT IS CLAIMED IS:

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1. A cantilever, comprising:

a probe part scanning an observed sample and an electrode part supporting said probe part, wherein

said probe part includes:

an insulator having a sharp-pointed solid shape and

a conductive wiring which is placed on a part of a side surface of said insulator, having one end reaching a peak of said solid shape and an opposite end reaching said electrode part.

- 2. The cantilever according to claim 1, wherein said conductive wiring is placed so as to be shortest in length.
- 3. A manufacturing method of a cantilever, comprising the steps of:
  - (a) forming a hole having a sharp-pointed solid shape in a surface of a substrate so that a peak is formed inside of said substrate;
  - (b) forming a sacrifice film to cover said surface of said substrate and a side surface of said hole having said solid shape;
- 20 (c) forming a conductive wiring in a side surface part of said hole having said solid shape on said sacrifice film so that one end reaches a peak of said hole having said solid shape;
  - (d) forming an insulator having a selective etching rate to said sacrifice film to fill up said hole having said solid shape after said step (c);
- 25 (e) forming an electrode part to cover an upper surface of said insulator, an

opposite end of said conductive wiring and said sacrifice film; and

- (f) separating said insulator, said conductive wiring and said electrode part from said substrate by etching said sacrifice film after said step (e).
- 5 4. The manufacturing method of the cantilever according to claim 3, wherein said step (c) includes the step of:

forming said conductive wiring so that the length from said sharp point of said hole having said solid shape to said surface of said substrate becomes shortest.